Multi-Resonant Class-F Power Amplifier Design for 5G Cellular Networks

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Abstract. This work integrates a harmonic tuning mechanism in synergy with the GaN HEMT transistor for 5G mobile transceiver applications. Following a theoretical study on the operational behavior of the Class-F power amplifier (PA), a complete amplifier design procedure is described that includes the proposed Harmonic Control Circuits for the second and third harmonics and optimum loading conditions for phase shifting of the drain current and voltage waveforms. The performance improvement provided by the Class-F configuration is validated by comparing the experimental and simulated results. The designed 10W Class-F PA prototype provides a measured peak drain efficiency of 64.7% at 1dB compression point of the PA at 3.6GHz frequency.

Keywords

Power Amplifiers, GaN HEMT, Class-F, Power dissipation, heat transfer

1. Introduction

The 5G mobile vision is expected to provide an enhanced broadband service, whilst addressing architectural changes to cater for massive scale connectivity (Internet of Things) that is driven by the vertical industries. A fully deployed 5G system will harness high-band small cell technology based on millimeter wave and advanced antenna technology, forming a tight synergy that will have a direct multiplier effect on the single link data rate performance, where design targets aim to achieve gigabit per second speeds. However, with the foreseen increase in mobile traffic, network operators also aim to reduce the cost of ownership of their networks, where operational expenses such as energy consumption represents a major cost. These requirements translate to energy efficient network designs, that profit all the way to the RF hardware. In fact, PAs represent the largest consumer of energy in the transceiver chipset, hence positioning power efficient designs are of paramount importance.

It is well known that high efficiency can be achieved in PAs at the compressed gain levels in the presence of small conduction angles. However, very small conduction angle at higher frequencies requires greater input voltage swing for similar output current excursions, which reduces the power gain [1]. While the higher output power can be guaranteed by maximizing both the output current and voltage swing, the maximum efficiency can be attained by minimizing the dissipated power in device. The non-overlapping drain waveforms condition enables the PA to fulfil this requirement. Harmonic terminating techniques enable PAs to provide higher efficiency by selecting appropriate waveforms. The overdriven Class-F PA proposed by Snider in [2], relies on the load impedance at the fundamental and harmonic frequencies whilst, Class-E or D focus on the transistor switching mode operation [3,4]. Harmonic engineered amplifiers, irrespective of the drain bias current and the pinching-off time of the transistor, enhance the fundamental voltage component for a sufficiently high input power level, while maintaining the DC power supplied to a similar level. In Class-F, F⁻¹ [5,6] and switched-mode approaches, the role of the generated harmonics is to ensure an appropriate wave-shaping. On the other hand, the restrictions imposed by the device output nonlinearities deteriorates the adverse effects of the phase imbalance on the fundamental output current and voltage waveforms.

To enhance the waveforms harmonic content, many contributions from experimental observation of the transistor operation to the introduction of innovative configurations have been proposed. In [7], the authors realized a GaAs MMIC Class-F PA at 14.3GHz incorporated an active phase array for higher date rate transmission. In that work, a Class-F PA is design in power stage and a driver stage is added to improve the large-signal gain at the expense of fabrication complexity and cost. The proposed MMIC PA can provide a drain efficiency of 50.4% and 19.7dB gain. In [8], an improvement in gain and efficiency are reported by the Class-F PA connected to the active antenna, where the impedance of the antenna is optimized to provide harmonic matching for the Class-F PA. Nevertheless, the internal parasitics of packaged transistors prevent the PA to deliver its optimum performance.

Concurrently, the continuous modes of operation have been proposed for providing high efficiency across a wide frequency range, where the short and open circuited load terminations are replaced by purely reactive harmonic termination. To expand the impedance design space, a concurrent continuous Class-F PA has been adapted in [9] that can provide 72.8% and 76.7% drain efficiency at 3.5 and 2.6 GHz, respectively. However, the continuous PA modes require to control the harmonic impedances precisely for high efficiency performance and should maintain high peak voltage waveforms over the frequency range, that can be supported only by high breakdown voltage technologies like GaN devices, otherwise, it results in low output power density.

In this work an optimized design procedure to enhance the efficiency and gain of a Class-F PA over the Class-B configuration, by adopting a proposed harmonic control technique for second and third harmonics tuning is described. This technique can effectively compensate the detrimental effects of the packaged GaN HEMT parasitic components. For this purpose, the Class-F PA' output power and efficiency expressions are discussed using device timedomain waveforms. Subsequently, the PA performance is validated through the layout design, test of the fabricated prototype as well as, analysis of the simulated and measurement results.

This work is organized as follows: a brief theory of Class-F PA is elaborated in Section 2; Section 3 is devoted to present the design procedure of PA; this section also includes the PA implementation and measurement results. The last Section outlines the conclusion of this work.

2. Basic Operation of Class-F Power Amplifier

PA efficiency can be improved by driving the active device into the triode or cut-off or regions, when either the current or voltage waveforms are shaped as a square wave. The flat waveform contains only odd frequency components when the harmonics are terminated with an open circuit at the intrinsic drain of the device. In the Class-F mode, this flattening is executed on the voltage waveform. Consequently, the correlated half-sinusoidal current and square-wave voltage spectra at the fundamental frequency has no RF dissipated power theoretically.

Whilst the general concept of multi-harmonic manipulation strategy is elaborated in [10,11], Raab [12] has studied the effects of tuning a finite order of harmonics on

the Class-F PA and derived the harmonic magnitudes required for flattening the voltage waveform. Nevertheless, the high-efficiency harmonic tuning techniques require to analyze the PA linearity characteristics or even enforce an external linearization circuit in multicarrier systems. In many harmonic injection PA stages, proper subsystem linearization techniques, have been adopted to combat spectral regrowth of incorporated signals. For linearity enhancement, the large-signal intermodulation distortion (IMD) sweet spot is introduced in [13], as a theoretical solution to achieve low IMD in the saturation region.

The analysis assumes that the transistor is controlled by the input gate-source voltage linearly and the intrinsic transistor output response is represented by the device transconductance. The half-sine wave drain current is expressed by (1).

$$i_D(t) = I_{DM} \cdot \cos(\omega_0 t) - \pi/2 < \omega_0 t < \pi/2$$
(1)

Where the maximum drain current is shown by I_{DM} . The drain current is equal to zero for $-\pi < \omega_0 t < -\pi/2$ and $\pi/2 < \omega_0 t < \pi$. Considering the third harmonic components, the representation of the drain voltage waveform can be obtained by (2).

$$v_D(t) = V_{dc} - V_1 \cos(\omega_0 t) + V_3 \cos(3\omega_0 t)$$
(2)

Where V_{dc} is the DC supply voltage. The peak-to-peak swing of the ac component of drain to source voltage waveform will be decreased because of adding the out-ofphase third harmonic component to the fundamental voltage, and the maximum ac component's value of voltage waveform becomes lower than the amplitude of the fundamental component V_1 . Besides, it is possible to raise the ratio V_1/V_{ds} by increasing the amplitude of the third harmonic component. When V_1 rises and the input power keeps constant, the output RF power and the drain efficiency will enhance by the same factor. This will be shown in the following analysis.

The Fourier coefficients for the maximum drain to source voltage can be obtained by setting the derivatives equal to zero. The first-order derivative is zero at the minimum value of $\omega_0 t = 0$ and the maximum value of $\omega_0 t = \pi$. From the second-order derivative at $\omega_0 t = 0$, (3) can be expressed by,

$$\frac{d^2 v_{DS}}{d(\omega_0 t)^2}\Big|_{\omega_0 t=0} = V_1 \cos \omega_0 t - 9V_3 \cos 3\omega_0 t = 0$$
(3)

Therefore, a maximum drain voltage waveform occurs when $V_3/V_1 = 1/9$, and the minimum drain-source voltage is obtained as (4).

$$V_{DSmin} = V_{ds} - V_1 + V_3 = V_{ds} - \frac{8}{9}V_1 = 0$$
(4)

That produces the maximum amplitude of the output voltage $V_1 = 9/8 V_{ds}$, and by substituting V_1 in (4), the required amplitude of the third harmonic voltage component can be attained as $V_3 = V_{ds}/8$.

The fundamental drain current amplitude can be unmatched 10W GaN HEMT device provided by Creeexpressed by, Wolfspeed is employed.

$$I_1 = \frac{9(V_{ds} - V_{DSmin})}{8R_I}$$
(5)

The DC input current and supply power are given respectively, by (6) and (7).

$$I_{DC} = \frac{1}{2\pi} \int_{-\frac{\pi}{2}}^{\frac{\pi}{2}} I_{DM} \cos \omega_0 t \, d(\omega_0 t) = \frac{2}{\pi} I_1 \tag{6}$$

$$=\frac{9V_{ds} + V_{DSmin}}{4\pi R}$$

$$P_{DC} = \frac{9V_{ds}(V_{ds} - V_{DSmin})}{4\pi R}$$
(7)

The drain-source voltage consists of the dc, fundamental and third harmonic components, and the drain current contains a dc, fundamental and second harmonic component [14,15], therefore, the RF output power includes the fundamental component,

$$P_{O} = \frac{1}{2} \cdot \frac{I_{DM}}{2} \cdot \frac{9}{8} (V_{ds} - V_{DSmin})$$

= $\frac{9}{32} I_{DM} (V_{ds} - V_{DSmin})$ (8)

Hence, the Class-F PA drain efficiency can be achieved by

$$\eta_D = \frac{P_O}{P_{DC}} = \frac{1}{2} \cdot \frac{\pi}{2} \cdot \frac{V_1}{V_{ds}} = \frac{\pi V_1}{4V_{ds}} = \frac{9\pi}{32} \left(1 - \frac{V_{DSmin}}{V_{ds}} \right)$$
(9)

It should be noted that the amplitude of the fundamental component V_1 has been increased with the third harmonic contribution to $V_1 = 9V_{ds}/8 = 1.125V_{ds}$ [16], thereby, the drain efficiency is increased by the same factor of 1.125.

3. Circuit Design of the Class-F PA

This section presents the design approach of 10W Class-F PA based on GaN HEMT technology. The design technology is hybrid-MIC microstrip on a Rogers4350 substrate ($\varepsilon_r = 3.66$ and h = 0.762).

3.1 Transistor Technology and Bias Selection

From the nonlinear HEMT model, it is known that the maximum efficiency is restricted by the output resistance of the transistor and the drain-source capacitance. The inherent high bandgap of Gallium Nitride (GaN) transistor offers the possibility of operating at high voltages, minimize the mismatch losses, and improve the thermal conductivity. Since, the high breakdown voltage provides more robust devices, GaN HEMTs on Silicon (Si) can maximize the power density and supply up to 180W output RF power at the base stations [17].

By moving further towards a fully digital radio in 5G and beyond, GaN HEMT MMIC PAs at X-band can provide up to 55% PAE and 40W output power [18,19]. In this paper, the



Fig. 1. *I*_{dS}-*V*_{GS} transfer characteristic.

The packaged GaN HEMT equivalent circuit, and specifically, the CGH40010F model, includes both intrinsic and package parasitics. The presence of parasitic wiring and nonlinear variation of V_{gs} with respect to the input voltage, pose severe implications for harmonic terminations. Fig. 1 shows the I_{ds} - V_{Gs} transfer characteristic for a fixed V_{ds} of 28V supply voltage. Note that selecting an appropriate PA conduction angle is important since, a bias point close to the threshold gate voltage increases the harmonic component. The selected bias point must ensure the third harmonic current is null. Here a bias point slightly lower than Class-B conduction angle at V_G =-3.1V is selected, while the lower bias points impose higher nonlinear operation regimes and provide in-phase third harmonic component.

3.2 The Rollet Stability Factor of the PA

The PA must be stable at all frequencies to prevent unwanted oscillations, in or out of the operating frequency band. The transistor nonlinear input capacitance exhibits negative resistance under a strong input power drive that results in a parametric generation of harmonic components [20]. The small-signal stability analysis of a PA mostly relies on the stability circles and Rollet Stability factor (K-factor), hence spurious power dependent intrinsic oscillation phenomena cannot be predicted by small-signal stability analysis. The geometric-derived stability factor from the sparameters can assure the stability that is expressed by:

$$\mu = \frac{1 - |S_{11}|^2}{|S_{22} - \Delta S_{11}^*| + |S_{12}S_{21}|} > 1$$
⁽¹⁰⁾

The determinant of the scattering matrix is expressed by Δ .

Observation of start-up analysis of either K>1 and $|\Delta|<1$, plotted in Fig. 2(a), will not guarantee unconditional stability, when the PA is terminated with an impedance having positive or zero resistances. Besides, the single geometric-derived parameter, $\mu>1$ shown in Fig. 2(b) guarantees the stability auxiliary condition. The work [22] provides the complementary large-signal stability-analysis techniques assisted to ensure the stability. By increasing the real part of impedance, the stability will be improved with

the penalty of gain reduction at the operating frequency. In this study, a series resistor at the input path of the transistor improves the output Return Loss.



Fig. 2. Stability factors:(a) K, Δ , (b) The geometrically derived load

3.3 Bias Network Consideration

Design of the gate/drain bias network includes some trade-offs among linearity, stability, and complexity. A proper gate bias line provides positive input resistance for achieving low-frequency stability [23,24]. Here, the desired bias-tees are synthesized first by decoupling capacitors to null the RF signal at the operating frequency. Then, a proper thickness of the $(\lambda/4)$ line provides a high impedance at the fundamental frequency. The minimum $\lambda/4$ line's width of 0.5mm with characteristic impedance of 80 Ω can handle the maximum 0.6A drain current for the selected substrate.

3.4 Design of Harmonic Tuning Networks

To minimize the parasitic effects of device, the impedance terminations of fundamental and harmonics are required to provide a perfect match. In this respect, the load-pull simulations are conducted through the varying load impedance values defined by a certain VSWR and variable phase. Here, the load-pull simulations of stabilized FET transistor are run for selecting the optimal output impedance that compromise between the maximum efficiency and maximum output RF power.

The optimum I-gen impedances at the drain of transistor for the third harmonic order are shown in Fig.3. The third harmonic is terminated close to the open circuit condition. The harmonic control of the Class-F PA is carried

out by a short circuited second harmonic load, while the third harmonic is selected to maximize the output power. To present appropriate fundamental and harmonic terminations, the output matching network (OMN) is designed and optimized that includes a third-harmonic peaking circuit using a resonant tank in series with the output.



Fig. 3. S11 of the fundamental impedance, second and third harmonics at I-gen plane.



Fig. 4. Schematic of the harmonic tuning networks incorporated to (a) OMN, (b) IMN.

Freq.	Z _{Load}	Z _{in}	
F_0	14.7+j*13.8	4.2-j*20	
$2F_0$	-j*18	0.01+j*0.09	
$3F_0$	j*98	0.4-j*110	

Tab. 1. Input and Output Impedances extracted by load-pull simulation.

The third harmonic voltage has a ratio of 1/9 to the fundamental voltage, as mentioned in Section 2, thus, the finite slope of a GaN device's knee boundary allows the third harmonic component to square-up the fundamental voltage waveform. Therefore, the voltage waveform contains a large amount of third harmonic component that pushes the fundamental voltage over the value dictated by the device physical limitations. Since, the third harmonic flattening do not affect the dissipated power, higher output power can be achieved. Fig. 4(a), illustrates the topology of the OMN using the proposed compact Harmonic Control Circuit (HCC). The electrical length of the transmission lines in the matching networks are optimized for the Rogers4350 substrate. A T-shape transmission line submatching network transfers the fundamental optimum load of 14.7+j*13.8 to the 50 Ω and delivers the maximum excursions of the drain waveforms.

To further improve the PAE and gain, the load-pull simulations are also conducted for second and third harmonics. The harmonic impedances are listed in Tab. 1. At the third harmonic frequency, the load impedance is a large value of purely imaginary while, the real part of harmonic impedance is too small to be ignored. The resonant circuit includes two open stub lines and two transmission lines connected by a junction. The electrical lengths of lines are tuned to control the harmonic terminations. To generate a proper drain current waveform, the λ 4 line (TL8) in bias network provides a very low impedance at the second harmonic that can eliminate the distortion in the input voltage.



Fig. 6. AM/PM and AM/AM PA characteristics without linearization.

The input matching network (IMN) is designed to maximize the gain level at the operating frequency. The purpose of harmonic tuning at the IMN shown in Fig.4(b), is to prevent the delivery of harmonic power to the load. Moreover, the input second harmonic impedance should be controlled as it affects the input nonlinearity. To deliver the maximum power transfer from the input source to the FET, the transistor's input is conjugate matched at the fundamental frequency. Input impedance (Z_{in}) of transistor at 3.6GHz is 4.2-j*20 and the IMN transfers the 50 Ω to the conjugate match of Z_{in} . Note that the HCCs are placed in front of the fundamental matching networks to prevent harmonic impedance variation. Fig. 5. indicates the drain waveforms of the designed Class-F PA. Moreover, the nonlinear characteristics of PA without predistortion linearization are plotted in Fig. 6, where a slight compression at high power levels can be observed.



Fig. 7. Layout of Class-F PA mode.



Fig. 8. Simulated gain, PAE and drain efficiency of Class-F VS those of Class-B PA.

As a final remark, electromagnetic simulations should be performed for estimating actual measurement results, by considering the sensitivity of the transmission lines tolerances and layout disposition. The schematic circuits of the 10W Class-F, including HCCs at input/output, and a single-ended Class-B PA using the same transistor and bias condition have been designed at 3.6GHz. The layout of the designed Class-F PA is depicted in Fig. 7 where the Class-B PA is extended with harmonic resonators to shape the output voltage waveform.

To show the effect of the harmonic voltage, the layout results of transducer power gain, drain efficiency and PAE of the Class-F PA are compared with those of the Class-B PA in Fig.8. Dashed lines are allocated to the performance of Class-B PA. The results reveal that while both Classes provide approximately the same saturated output power, Class-F PA delivers about 13% higher PAE where the dissipation in transistor is minimized. Therefore, the harmonic tuning contributes in higher efficiency. The Class-B PA provides linear amplification by setting a perfect shortcircuit at all relevant harmonics, hence the instantaneous efficiency varies linearly with the output voltage. Besides, the Class-F PA has superior drain efficiency performance of 66% and gain flatness of 13.7dB over the Class-B PA, with 56% drain efficiency and transducer gain of 11.3dB.

3.5 PA Prototype Implementation and Experimental Results

We fabricated the corresponding Class-F PA prototype for 3.6 GHz operating frequency, to evaluate the inherent operation of the wave-form engineering. Fig. 9(a) depicts the photo of the assembly mounted on an aluminium plate and the PCB dimensions. The blocking capacitors models of the ATC 800-A series are used. These capacitors provide heat transfer for high RF power levels.





Fig. 9. (a) The PCB prototype of the Class-F PA with the dimention of 86mmx31mm. (b) Measurement test-bench for the PA.

Fig. 9(b) exhibits the employed setup for PA measurement and test. It consists of an RF power driver (Mini-Circuit ZVE-8G+) to generate the input signal, and the Spectrum Analyser (SMW200A) to measure the output RF signal. A calibrated 30dB fixed attenuator (BW-30N100W+) is used as a protective element to prevent the VSA to be overloaded at high power levels. The PA was tested with power-swept continuous wave (CW) excitations from a vector signal generator (R&SFSW8) to study the PA behaviour under different excitation levels. The fundamental voltage has been increased with the input power drive; hence the current is saturated.

The large-signal performance of the PA with 28V V_{ds} and quiescent drain current of 15mA is shown in Fig. 10. The measured results (dashed lines) are compared to the simulated ones (solid lines).



Fig. 10. Experimental results of (a) output power and gain, (b) drain efficiency, (c) transducer power gain.(d) PAE VS Pout.

As depicted in Fig. 10(a, b) the PA provides a measured peak drain efficiency of 64.7% at 40dBm output power, while it operates at its 1dB compression point. Fig.

10(c) plots the small-signal gain variation through a frequency sweep from 3.4 to 3.7 GHz. The transducer power gain at 3.56GHz is approximately close to the simulation result, even though at 3.6GHz is lower than the simulation predicts. A maximum measured transducer power gain of 11dB is achieved showing a 2dB difference with respect to the simulation results. For higher power levels, this difference decreases. Measurement results depict the effectiveness of employed HCC when the peak PAE of 59.6% has been achieved at maximum RF output power whilst, the IMN improves the input reflection coefficient and the gain response versus frequency. Fig.10(d) depicts the measured results of PAE, drain efficiency and gain versus output power. The results indicate the experimental measurements are well-matched with the simulated results, considering the fabrication tolerances.

The obtained results are compared favourably with recently published papers on state-of-the-art Class-F PAs, listed in Tab. 2. The results confirmed that the design methodology proposed in this paper can deliver high efficiency and high linear performance without using predistortion technique. The harmonic distortion of -52.51dBc for the second harmonic and -37.41dBc for the third harmonic, in the measured output power spectrum, validated the results. In summary, wave-shaping matching design methodologies improve the power amplifier large-signal performance in conjunction with advanced device technologies, providing solutions suitable for 5G transmitters.

Refs.	Freq. GHz	PAE %	P _{out} dBm	Device	Gain dB
[9]	0.55-0.95	70-86	40	GaN HEMT	15
[25]	5.7	68	34	GaN HEMT	9.5
[26]	2.5	50	40	GaN HEMT	14
[27]	5	58	28	GaAs pHEMT	13.5
[28]	1.45-2.45	60-65	40.41-42	GaN HEMT	10-12.6
This work	3.6	59.6	40	GaN HEMT	11.2

Tab. 2. Performance comparison summary of Class-F PAs.

4. Conclusion

This work contributes to experimentally validate the harmonic tuning influence on the efficiency improvement of a Class-F PA, based on GaN HEMT technology for 5G applications. The designed amplifier complies with the design rules required for the quiescent point, second and third harmonic terminations. The bias network is shaped by the desired trade-off between RF isolation, current-handling and low-frequency stability. The harmonic content of the output current and voltage waveforms, shaped by appropriate terminations, minimize the overlapping region and hence the amount of dissipated power. The measured results of hybrid MIC microstrip technology are coherent with the simulated results.

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References

- RODRIGUEZ, J., et al. SECRET—Secure Network Coding for Reduced Energy Next Generation Mobile Small Cells: A European Training Network in Wireless Communications and Networking for 5G. 2017 Internet Technologies and Applications (ITA), 2017, p. 329–333. DOI:<u>10.1109/ITECHA.2017.8101964</u>
- [2] SNIDER, D.M. A theoretical analysis and experimental confirmation of the optimally loaded and overdriven RF power amplifiers, *IEEE Trans Electron Devices*, 1967, vol. 14, p.851-857 DOI: <u>10.1109/T-ED.1967.16120</u>
- [3] CRIPPS, S.C. RF power amplifiers for wireless communications, Artech House. London UK, 2006. ISBN: 0890069891, 9780890069899
- [4] CRIPPS, S.C., et al. On the continuity of high efficiency modes in linear RF power amplifiers. *IEEE Microw. Wireless Compon. Lett.* 2009, vol. 19, no. 10, p. 665-667. DOI: <u>10.1109/LMWC.2009.2029754</u>
- [5] COLANTIONIO, P., GARCIA, J. A., GIANNINI, F., GOMEZ, C., CARVALHO, N. B., LIMITI, E., PEDRO, J.C. High Efficiency and High Linearity Power Amplifier Design, John Wiley & Sons RF and Microwave CAE, 2005, p.453-468. DOI: <u>10.1002/mmce.20111</u>
- [6] LEE, Y., LEE, M. and JEONG, Y., High-Efficiency Class-F GaN HEMT Amplifier with Simple Parasitic-Compensation Circuit *IEEE MICROWAVE AND WIRELESS COMPONENTS LETTERS*, 2008, vol. 18, no. 1, p.55-57. DOI: <u>10.1109/LMWC.2007.912023</u>
- [7] DHAR, S. K. et al. Design methodology of Broadband Continuous Class-F Power Amplifiers for Sub-6-GHz 5G Applications, *IEEE Transactions on Microwave Theory and Techniques*, 2020, vol.68, no.7, p. 3120-3133, DOI: 10.1109/TMTT.2020.2984603.
- [8] WREN, M., and BRAZIL, T. J., Experimental Class-F Power Amplifier Design Using Computationally Efficient and Accurate Large-Signal pHEMT Model. *Transactions on Microwave Theory* and *Techniques*, 2005, vol. 53, no. 5, p.1723-1731. DOI: <u>10.1109/TMTT.2005.847108</u>
- [9] SHARMA, T., DARRANJI, R., GHANNOUCHI, F. High efficiency Class-F MMIC power amplifiers at ku-band, *The 2005 IEEE Annual Conference Wireless and Microwave Technology*, 2005, Clearwater Beach, FL, (USA), p. 24-28. DOI: <u>10.1109/WAMIC.2005.1528402</u>
- [10] YANG, Z., et al. A Precise Harmonic Control Technique for High Efficiency Concurrent Dual-Band Continuous Class-F Power Amplifier, *IEEE Access*, 2018, vol. 6, p. 51864-51874, DOI: 10.1109/ACCESS.2018.2870865.
- [11] SAJEDIN, M. et al. Energy Efficient and Wideband Class-J Doherty Power Amplifier, 2020 12th International Symposium on Communication Systems, Networks and Digital Signal Processing (CSNDSP), Porto, (Portugal), 2020, p. 1-6, DOI: 10.1109/CSNDSP49049.2020.9249642.
- [12] COLANTONIO, P., GANNINI, F., LEUZZI, G., LIMITI, E. Multiharmonic manipulation for highly efficient microwave power amplifiers. *Wiley & Sons, Inc.*, 2001, vol. 11, no. 6, p.366-383. DOI: 10.1002/mmce.1045

- [13] RAAB, F. Class-f power amplifiers with maximally flat waveforms, *IEEE Trans. Microw. Theory Tech.* 1997, Vol. 45, no.11, p. 2007 – 2012. DOI: 10.1109/22.644215.
- [14] PEDRO, J. C., CARVALHO, N. B., FAGER, C., GARCIA, J.A, Linearity versus efficiency in mobile handset power amplifiers: a battle without a loser. *Microwave Engineering Europe*. 2004. p.19-26
- [15] COLANTONIO, P. et al. On the Class-F Power Amplifier Design. John Wiley & Sons RF and Microwave CAE 9.1999. p.129-149.DOI: 10.1002/(SICI)1099-047X (199903)9
- [16] KAZIMIERCZUK, M. RF Power Amplifier, New York (USA), Wiley, 2008, Ch. 8, p. 267-289. ISBN: 9781118844373
- [17] SAJEDIN. M., et al. A Survey on RF and Microwave Doherty Power Amplifier for Mobile Handset Applications. *Electronics*, 2019, vol. 8, no. 6. p.1-31. DOI: 10.3390/electronics8060717
- [18] BAHL, I., BLASS, B., Microwave solid state circuit design. Canada, John Wiley & Sons. 2003, ISBN: 978-0-471-20755-9
- [19] SAJEDIN, M., et al. Advancement of a Highly Efficient Class-F Power Amplifier for 5G Doherty Architectures, 2019 *IEEE 2nd 5G World Forum (5GWF)*, Germany, 2019, p. 86-90. DOI: <u>10.1109/5GWF.2019.8911678</u>
- [20] GIANNINI, F., LEUZZI, G., Nonlinear Microwave Circuit Design. UK, John Wiley & Sons, Ltd. 2004. ISBN: 978-0-470-84701-5
- [21] CABRAL, P.M., PEDRO, J.C., CARVALHO, B. Nonlinear device model of microwave power GaN HEMTs for high power-amplifier design, *IEEE Trans. Microw. Theory Tech.* 2004, vol. 52, no. 11, p. 2585–2592, DOI: 10.1109/TMTT.2004.837196.
- [22] ABDULKHALEGH, A.M., et al. Recent Developments of Dual-Band Doherty Power Amplifiers for Upcoming Mobile Communications Systems, *Electronics*, 2019, vol. 8, no. 6, p.1-19. DOI: <u>10.3390/electronics8060638</u>
- [23] DU, X., et al. Analytical Design Space of Power Amplifiers Including the Class-A/B/J Continuum for Dynamic Load Modulation. *IEEE Access*, 2019, vol. 7, p. 71933-71942, DOI:10.1109/ACCESS.2019.2919379
- [24] MOON, J., et al. Behaviors of Class-F and Class- F⁻¹ Amplifiers. 2012, *IEEE Trans. Microw. Theory Tech*, vol. 60, no. 6, p.1937-1951. DOI: 10.1109/TMTT.2012.2190749.
- [25] AGGRAWAL, E., RAWAT, K., ROBLIN, P. Investigating continuous Class-F power amplifier using nonlinear embedding model, *IEEE Microw. Wireless Compon. Lett.*, 2017, vol. 27, no. 6, p. 593–595. DOI: 10.1109/LMWC.2017.2701316.
- [26] KURODA, K., ISIKAWA, R., KAZUHKIOK, H. High-Efficiency GaN-HEMT Class-F Amplifier Operating at 5.7 GHz, 2008 38th European Microwave Conference, Amsterdam, Netherlands, 2008, p. 440-443, DOI: 10.1109/EUMC.2008.4751483.
- [27] NICKANDISH, G., BABAKPUR, E., MEDI, A. A harmonic termination technique for single- and multi band high-efficiency Class-F MMIC power amplifiers. *IEEE Trans Microwave Theor Tech* 2014, vol. 62, no. 5, p.1212–1220. DOI: 10.1109/TMTT.2014.2315591.
- [28] TUFFY, N., GUAN, L., ZHU, A., and BRAZIL, T. A Simplified Broadband Design Methodology for Linearized High-Efficiency Continuous Class-F Power Amplifiers, *IEEE Transactions on Microwave Theory and Techniques*, 2012, vol. 60, no. 6, p. 1952-1963, DOI: 10.1109/TMTT.2012.2187534.

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